

# MP2117

1.25MHz, 2.2A Synchronous Step-Down Switcher

**END OF LIFE, REFER TO MP1605** 

### DESCRIPTION

The MP2117 is an internally compensated 2.2A synchronous step-down switcher. The operating frequency is internally set at 1.25MHz. MP2117 is ideal for powering portable equipment that runs from a single cell Lithium-Ion (Li+) Battery. The MP2117 can provide up to 2.2A continuous load current from a 2.5V to 6V input voltage. The output voltage can be regulated as low as 0.6V. 100% duty cycle provides low dropout operation that extends operating time in battery-operated systems.

The MP2117 features an integrated high-side switch and synchronous rectifier for high efficiency. With peak current mode control and internal compensation, the MP2117 can be stabilized with ceramic capacitors and small inductors. Fault condition protection includes cycle-by-cycle current limiting and thermal shutdown.

MP2117 is available in the small 10-pin 3mmx3mm QFN and SOIC-8 packages.

### **FEATURES**

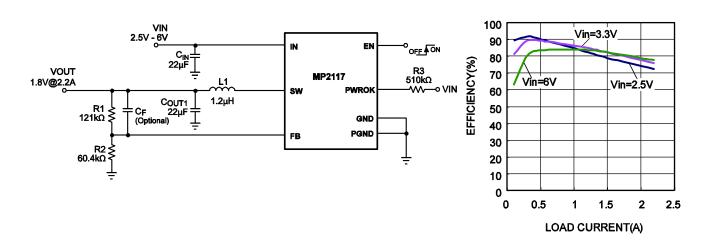
- 2.2A Output Current
- 2.5V to 6V Input Range V<sub>IN</sub>
- Internal Power MOSFET Switches
- Low Dropout Operation: 100% Duty Cycle
- Up to 90% Efficiency
- Stable with Ceramic Output Capacitors
- 1µA Shutdown Current
- 1.25MHz Switching Frequency
- Thermal Shutdown
- Cycle-by-Cycle Over Current Protection
- Output Short Circuit Protection
- Internal Soft-start
- Power On Reset Output
- Available in 10-Pin QFN (3mmx3mm) and 8-pin SOIC Packages

#### **APPLICATIONS**

- DVD+/-RW Drives
- LCD TV
- PDAs
- Portable Instruments

#### TYPICAL APPLICATION

#### Efficiency vs. Load Current



© 2023 MPS. All Rights Reserved.

<sup>&</sup>quot;MPS" and "The Future of Analog IC Technology" are Registered Trademarks of Monolithic Power Systems, Inc.

### ORDERING INFORMATION

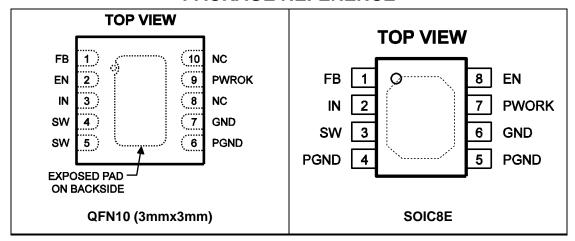
\*For Tape & Reel, add suffix –Z (eg. MP2117DQ–Z): For RoHS compliant packaging, add suffix –LF (eg.

Part Number*	Package	Top Marking	Temperature
MP2117DQ	QFN10 (3mmx3mm)	S4	-40°C to +85°C
Part Number**	Part Number** Package		Temperature
MP2117DN	SOIC8E	MP2117DN	-40°C to +85°C

MP2117DQ-LF-Z). CONTACT FACTORY

\*\*For Tape & Reel, add suffix –Z (eg. MP2117DN–Z): For RoHS compliant packaging, add suffix –LF (eg. MP2117DN–LF–Z). CONTACT FACTORY

### PACKAGE REFERENCE



## ABSOLUTE MAXIMUM RATINGS (1)

IN to GND	–0.3V to + 6.5V
SW to GND	$-0.3V$ to $V_{IN} + 0.3V$
	2.5V, Transient <50ns;
V <sub>SW</sub> <+8	3.5V, Transient <50ns)
PWROK to GND	0.3V to +6.5V
FB, EN to GND	0.3V to +6.5V
Operating Temperature	–40°C to +85°C
Continuous Power Dissip	ation $(T_A = +25^{\circ}C)^{(2)}$
SOIC8E	2.5W
QFN10 (3mm x 3mm)	2.5W
Junction Temperature	150°C
Lead Temperature	260°C
Storage Temperature	

Recommended Operation	ng Conditions <sup>(3)</sup>
Supply Voltage V	2 5\/ to 6\/

Supply voltage v <sub>IN</sub>	2.5V 10 6V
Output Voltage V <sub>OUT</sub>	0.6V to 6V
Operating Temperature	40°C to +85°C

Thermal Resistance (4)	$oldsymbol{ heta}_{JA}$	$oldsymbol{ heta}$ JC
QFN10 (3mm x 3mm)	50	12 °C/W
SOIC8E	50	10 °C/W

#### Notes:

- 1) Exceeding these ratings may damage the device.
- 2) The maximum allowable power dissipation is a function of the maximum junction temperature  $T_J$  (MAX), the junction-to-ambient thermal resistance  $\theta_{JA}$ , and the ambient temperature  $T_A$ . The maximum allowable continuous power dissipation at any ambient temperature is calculated by  $P_D$  (MAX) =  $(T_J$  (MAX)- $T_A$ )/ $\theta_{JA}$ . Exceeding the maximum allowable power dissipation will cause excessive die temperature, and the regulator will go into thermal shutdown. Internal thermal shutdown circuitry protects the device from permanent damage.
- The device is not guaranteed to function outside of its operating conditions.
- 4) Measured on JESD5 1-7, 4-layer PCB.

# **ELECTRICAL CHARACTERISTICS (5)**

 $V_{IN} = V_{EN} = 3.6V$ ,  $T_A = +25$ °C, unless otherwise noted.

Parameters	Condition	Min	Тур	Max	Units	
No Load Supply Current	V <sub>IN</sub> = 3.6V, V <sub>EN</sub> =3.6V V <sub>FB</sub> = 0.65V		350	500	μΑ	
Shutdown Current	V <sub>EN</sub> = 0V, V <sub>IN</sub> = 6V		0.01	1	μΑ	
Thermal Shutdown Trip Threshold	Hysteresis = 20°C		150		°C	
PWROK Upper Trip Threshold	FB with respect to the Nominal Value		10		%	
PWROK Lower Trip Threshold	FB with respect to the Nominal Value		-10		%	
PWROK Output Lower Voltage	I <sub>SINK</sub> = 5mA			0.3	V	
PWROK Deglitch Timer			50		μs	
EN Trip Threshold	–40°C ≤ T <sub>A</sub> ≤ +85°C	0.3		1.5	V	
EN Pull Down Resistor			1		МΩ	
IN Under Voltage Lockout Threshold	Rising Edge, Hysteresis=0.3V	1.8	2.2		V	
Demilated ED Valtage	$T_A = +25^{\circ}C$	0.584	0.596	0.608	$\longrightarrow$ $\lor$ $\lor$	
Regulated FB Voltage	–40°C ≤ T <sub>A</sub> ≤ +85°C	0.578	0.596	0.614		
FB Input Bias Current	V <sub>FB</sub> = 0.62V	-50		+50	nA	
SW PFET On Resistance	Isw = 100mA		0.20		Ω	
SW NFET On Resistance	Isw = -100mA		0.15		Ω	
SW Leakage Current	$V_{EN} = 0V$ , $V_{IN} = 6V$ $V_{SW} = 0V$ or $6V$			+5	μΑ	
SW PFET Peak Current Limit	Duty Cycle = 100%, Current Pulse Width < 1ms		3.3	4.5	А	
Oscillator Frequency		1.00	1.25	1.50	MHz	

#### Notes:

## **PIN FUNCTIONS**

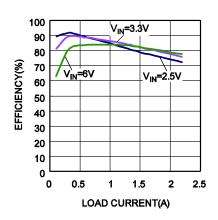
QFN Pin #	SOIC Pin #	Name	Description
1	1	FB	Feedback Input for the switcher output VOUT.
2	8	EN	Enable Input for the switcher.
3	2	IN	Input Supply Pin.
4, 5	3	SW	Switcher switch node.
6	4, 5	PGND	Low Side Synchronous Rectifier Switch Power Ground.
7	6	GND	Chip Analog Ground. Connect the Exposed Pad to GND.
9	7	PWROK	Power On Reset Open Drain Output. HIGH output indicates that the output is within $\pm 10\%$ of the regulation value. LOW output indicates that the output is out of $\pm 10\%$ window. PWROK is pulled down in shutdown. The PWROK window comparators have 50us deglitch timer to avoid false trigger during load transient.
8, 10	-	N/C	No Connection.

<sup>5)</sup> Production test at +25°C. Specifications over the temperature range are guaranteed by design and characterization.

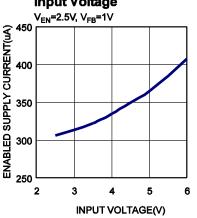
## TYPICAL PERFORMANCE CHARACTERISTICS

 $V_{IN} = 5V$ ,  $V_{OUT} = 1.8V$ , L=1.2uH,  $T_A = +25^{\circ}C$ , unless otherwise noted.

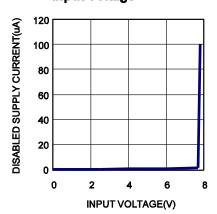
#### **Efficiency vs. Load Current**



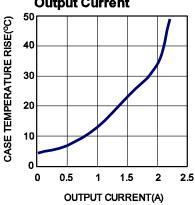
# Enabled Supply Current vs. Input Voltage



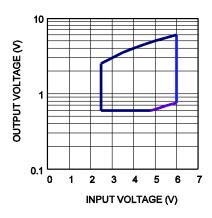
# Disabled Supply Current vs. Input Voltage



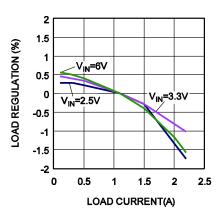
# Case Temperature Rise vs. Output Current



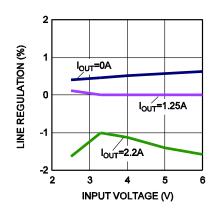
## **Operating Range**



## **Load Regulation**



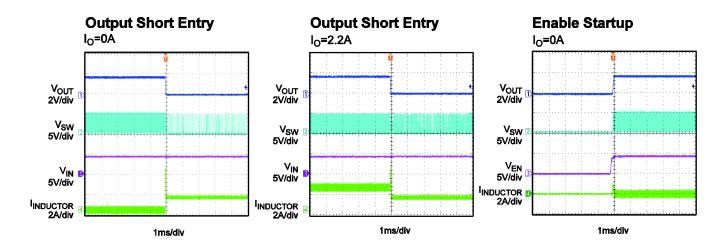
### **Line Regulation**

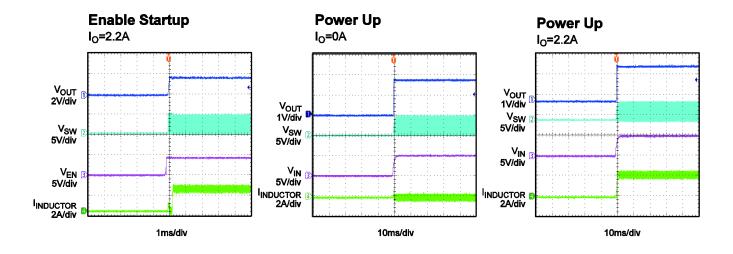


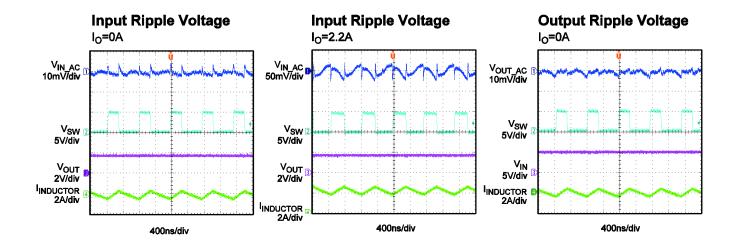


# TYPICAL PERFORMANCE CHARACTERISTICS (continued)

 $V_{IN} = 5V$ ,  $V_{OUT} = 1.8V$ , L=1.2uH,  $T_A = +25^{\circ}$ C, unless otherwise noted.

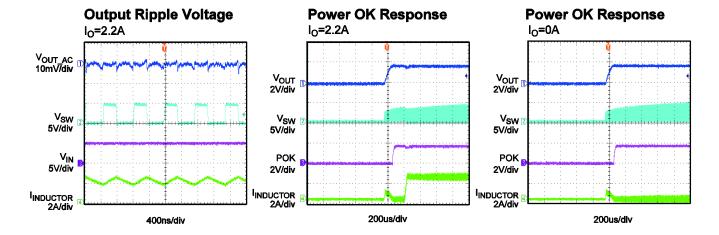






# **TYPICAL PERFORMANCE CHARACTERISTICS (continued)**

 $V_{IN} = 5V$ ,  $V_{OUT} = 1.8V$ , L=1.2uH,  $T_A = +25^{\circ}C$ , unless otherwise noted.



#### **OPERATION**

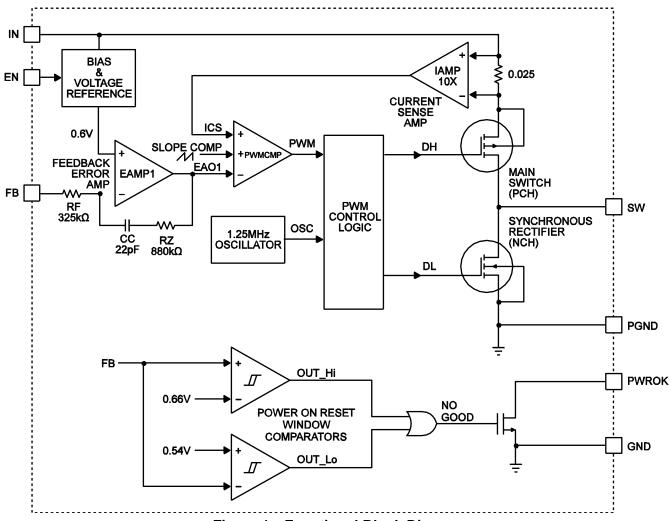


Figure 1—Functional Block Diagram

The MP2117 is a 1.25MHz fixed frequency current mode synchronous step-down switcher. The MP2117 is optimized for low voltage, Li-lon battery powered applications where high efficiency and small size are critical. The MP2117 can provide up to 2.2A continuous load current from a 2.5V to 6V input voltage.

The MP2117 uses an external resistor divider to set the switcher output voltage from 0.6V to 6V.

### 2.2A Step-Down Switcher

The switcher integrates both a main switch and a synchronous rectifier, which provides high efficiency and eliminates an external Schottky diode.

The duty cycle D of a step-down switcher is defined as:

$$D = T_{ON} \times f_{OSC} \times 100\% \approx \frac{V_{OUT}}{V_{IN}} \times 100\%$$

Where  $T_{\text{ON}}$  is the main switch on time and  $f_{\text{OSC}}$  is the oscillator frequency (1.25MHz).

#### **Current Mode PWM Control**

Slope compensated current mode PWM control provides stable switching and cycle-by-cycle current limiting for superior load and line response in addition to protection of the internal main switch and synchronous rectifier. The MP2117 switches at a constant frequency (1.25MHz) and regulates the output voltage. During each cycle the PWM comparator



modulates the power transferred to the load by changing the inductor peak current based on the feedback error voltage. During normal operation, the main switch is turned on for a certain time to ramp the inductor current at each rising edge of the internal oscillator, and switched off when the peak inductor current is above the error voltage. When the main switch is off, the synchronous rectifier will be turned on immediately and stay on until the next cycle starts.

### **Dropout Operation**

The MP2117 allows the main switch to remain on for more than one switching cycle and increases the duty cycle while the input voltage is dropping close to the output voltage. When the duty cycle reaches 100%, the main switch is held on continuously to deliver current to the output up to the PFET current limit. The output voltage then becomes the input voltage minus the voltage drop across the main switch and the inductor.

#### **Short Circuit Protection**

When the output is shorted to ground, the oscillator frequency is reduced to prevent the inductor current from increasing beyond the PFET current limit. The PFET current limit is also reduced to lower the short circuit current. The frequency and current limit will return to the normal values once the short circuit condition is removed and the feedback voltage reaches 0.6V.

#### **Maximum Load Current**

The MP2117 can operate down to 2.5V input voltage; however the maximum load current decreases at lower input due to a large IR drop on the main switch and synchronous rectifier. The slope compensation signal reduces the peak inductor current as a function of the duty cycle to prevent sub-harmonic oscillations at duty cycles greater than 50%. Conversely, the current limit increases as the duty cycle decreases.

#### **Power OK**

The MP2117 provides an open-drain PWROK output that goes high after the output reaches regulation during startup. PWROK goes low after the output goes out of regulation by ±10% or when device enters shutdown. There is 50µsec deglitch timer built in to avoid PWROK false triggered during load transient.

#### **Enable Control**

MP2117 has a dedicated Enable control pin. By pulling it to high or low, the IC can be enabled and disabled by EN. Tie EN to VIN by proper voltage divider for automatic start up as Figure 2 shows. And make sure that:

$$\text{Max. EN Threshold} < V_{\text{IN}} \times \frac{R_{\text{EN2}}}{(R_{\text{EN1}} + R_{\text{EN2}})} < 6V$$

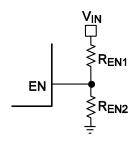


Figure 2

### **APPLICATION INFORMATION**

### **Output Voltage Setting**

The external resistor divider sets the output voltage. It is optional to speed loop response by adding a small feedforward capacitor  $C_F$  parallel with R1. Choose R1\* $C_F$  time constant around 3usec.

Choose R2 value between  $1k\Omega$  and  $100k\Omega$ . R1 is then given by:

$$R1 = R2 \times (\frac{V_{OUT}}{0.6V} - 1)$$

# Table 1—Resistor Selection vs. Output Voltage Setting

V <sub>OUT</sub>	R1	R2
1.2V	60.4kΩ	60.4kΩ
1.5V	90.9kΩ	60.4kΩ
1.8V	121kΩ	60.4kΩ
2.5V	191kΩ	60.4kΩ)
3.3V	274ΚΩ	60.4kΩ

#### **Inductor Selection**

A 1 $\mu$ H to 10 $\mu$ H inductor with DC current rating at least 25% higher than the maximum load current is recommended for most applications. For best efficiency, the inductor DC resistance should be <100m $\Omega$ . See Table 2 for recommended inductors and manufacturers. For most designs, the inductance value can be derived from the following equation:

$$L = \frac{V_{OUT} \times \left(V_{IN} - V_{OUT}\right)}{V_{IN} \times \Delta I_{L} \times f_{OSC}}$$

Where  $\Delta I_{L}$  is inductor ripple current. Choose inductor ripple current approximately 30% of the maximum load current, 2.2A.

The maximum inductor peak current is:

$$I_{L(MAX)} = I_{LOAD(MAX)} + \frac{\Delta I_{L}}{2}$$

**Table 2—Suggested Surface Mount Inductors** 

Manufacturer	Part Number	Inductance (µH)	Max DCR (mΩ)	Saturation Current (A)
Wurth	7447745012	1.2	17	4.6
Toko	D62LCB-#A918CY-1R0M	1.0	17	3.7

#### Switcher Input Capacitor C<sub>IN1</sub> Selection

The input capacitor reduces the surge current drawn from the input and switching noise from the device. The input capacitor impedance at the switching frequency should be less than input source impedance to prevent high frequency switching current passing to the input. Ceramic capacitors with X5R or X7R dielectrics are highly recommended because of their low ESR and small temperature coefficients. For most applications, a 10µF~22µF capacitor is sufficient.

#### Switcher Output Capacitor Cout Selection

The output capacitor keeps output voltage ripple small and ensures regulation loop stable. The output capacitor impedance should be low at the switching frequency. Ceramic capacitors with X5R or X7R dielectrics are recommended. For most applications, a  $22\mu\text{F}\sim47\mu\text{F}$  capacitor is sufficient.

The output ripple  $\Delta V_{OUT}$  is approximately:

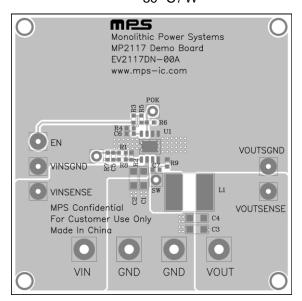
$$\Delta V_{\text{OUT}} \leq \frac{V_{\text{OUT}} \times (V_{\text{IN}} - V_{\text{OUT}})}{V_{\text{IN}} \times f_{\text{OSC}} \times L} \times \left( \text{ESR} \frac{1}{8 \times f_{\text{OSC}} \times C_{\text{OUT}}} \right)$$

#### **Thermal Dissipation**

Power dissipation should be considered when MP2117 provide maximum 2.2A output current to the loads at high ambient temperature. If the junction temperature rises above 150°C, the MP2117 will be shut down.

The junction-to-ambient thermal resistance of the 10-pin QFN or 8-pin SOIC  $R_{\Theta JA}$  is 50°C/W. The maximum power dissipation is about 1.6W when the MP2117 is operating in a 70°C ambient temperature environment.

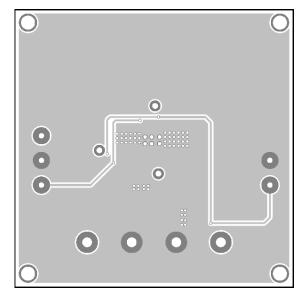
$$PD_{MAX} = \frac{150^{\circ}C - 70^{\circ}C}{50^{\circ}C/W} = 1.6W$$



**Top Layer** 

#### **PCB Layout**

The high current paths (GND, IN, OUT and SW) should be placed very close to the device with short, direct and wide traces. Input capacitors should be placed as close as possible to the respective IN and PGND pins. The external feedback resistors should be placed next to the FB pins. Keep the switching nodes SW short and away from the feedback network. An external diode (i.e. B130) can be added between SW and GND to reduce switching noise and to improve the load regulation. The reference layout and its schematic are shown below:



**Bottom Layer** 

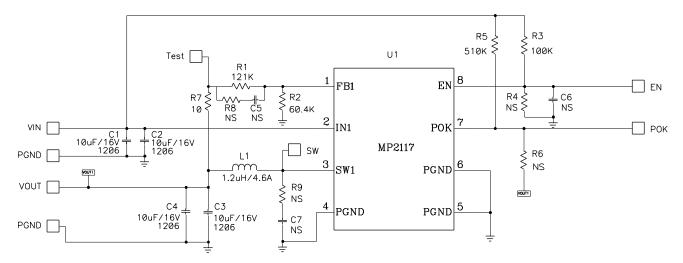
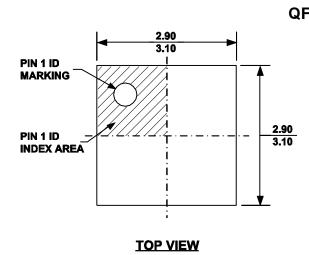
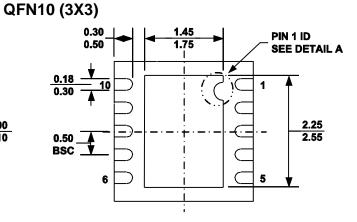


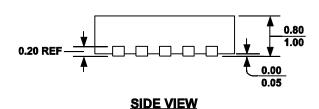
Figure 3

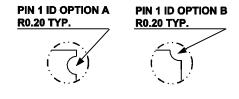
## **PACKAGE INFORMATION**



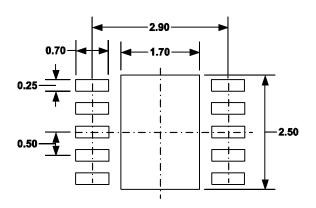


**BOTTOM VIEW** 





**DETAIL A** 

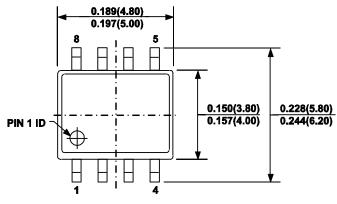


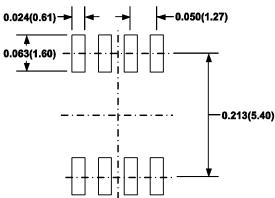
#### **RECOMMENDED LAND PATTERN**

#### NOTE:

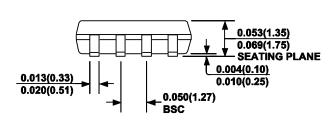
- 1) ALL DIMENSIONS ARE IN MILLIMETERS.
- 2) EXPOSED PADDLE SIZE DOES NOT INCLUDE MOLD FLASH.
- 3) LEAD COPLANARITY SHALL BE 0.10 MILLIMETER MAX.
- 4) DRAWING CONFORMS TO JEDEC MO-229, VARIATION VEED-5.
- 5) DRAWING IS NOT TO SCALE.

# SOIC8E



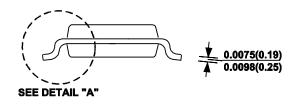


#### **RECOMMENDED LAND PATTERN**

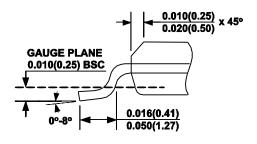


**FRONT VIEW** 

**TOP VIEW** 



**SIDE VIEW** 



**DETAIL "A"** 

#### NOTE:

- 1) CONTROL DIMENSION IS IN INCHES. DIMENSION IN BRACKET IS IN MILLIMETERS.
- 2) PACKAGE LENGTH DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.
- 3) PACKAGE WIDTH DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSIONS.
- 4) LEAD COPLANARITY (BOTTOM OF LEADS AFTER FORMING) SHALL BE 0.004" INCHES MAX.
- 5) DRAWING CONFORMS TO JEDEC MS-012, VARIATION AA.
- 6) DRAWING IS NOT TO SCALE.

**Notice:** The information in this document is subject to change without notice. Please contact MPS for current specifications. Users should warrant and guarantee that third-party Intellectual Property rights are not infringed upon when integrating MPS products into any application. MPS will not assume any legal responsibility for any said applications.